



Rolls Compliant

SPECIFICATION FOR APPROVAL

CUST	OMER'S APPROVAL CHOP	
Approval's condition:		
Approved date:		

KINDLY RETURN A SET WITH YOUR COMPANY'S OFFICIAL STAMP ON APPROVAL OF THIS ITEM

CUSTOMER'S NAME:			
CUSTOMER'S MODEL NO. :			
CUSTOMER'S PART NO. :			
DESCRIPTION:		Dielectric Filter	
Semitel'S MODEL NO. :	SE4R4750B300_10.2_084		
VERSION:	01		
DATE:	2025/7/10		
Attachments:	Prepared By	Checked By	Approved By
□ Product specification			
☐ Sample Qty.:	Hebe Deng 2025/7/10	Liang Wong 2025/7/10	Eric Chang 2025/7/10
□ Test data			

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Revision Record

Version	Revision Date	Revision For Items	Reason For Revision
01	2025/7/10	New Revision	

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1.FEATURES

- Small Size, Light weight
- SMT package soldering
- Ideal for Microwave telecommunication

2.SPECIFICATIONS

ELECTRICAL SPECIFICATIONS			
NO.	ITEM	SPEC UNIT	
1	Center Frequency [fo]	4750	MHz
2	Bandwidth [BW]	fo ±150 [4600~4900]	MHz
3	Insertion in BW	1.5 max.	dB
4	Ripple in BW	0.6 max.	dB
5	Return Loss in BW (S11, S22)	14.0 min.	dB
		40 min. @ 1~2500 MHz	dB
6	6 Attenuation [Absolute Value]	35 min. @ 2500~4000 MHz	dB
		14 min. @ 5050~5900 MHz	dB
7	In/Out Impedance	50	Ω
8	Input Power	2 avg/ 20 peak	w
9	Operation Temperature Range	-40℃ to +105℃	

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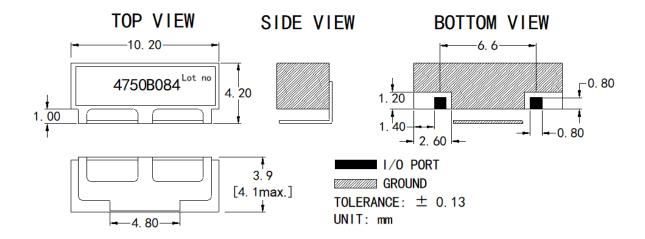




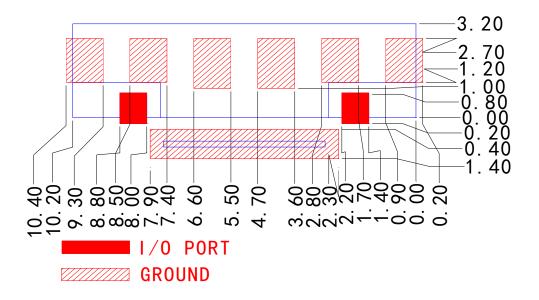
3.OUTLINE DRAWING

3.1. Filter drawing

3.2. SE4R4750B300_10.2_084 (marking showing 4750Bxxx, xxx=001~999 mean for project series code.)



4.RECOMMENDED PC BOARD PATTERN



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5.Environmental Test

5.1. Vibration Resist

The device should satisfy the electrical characteristics after applied to the vibration of 10 to 55Hz with amplitude of 1.5mm for 2 hours each in X, Y and Z directions.

5.2. Steady Damp Heat Test

The device should satisfy the electrical characteristics after exposed to the temperature 40±2℃ and the relative humidity 90~95% RH for 96 hours and 1~2 hours recovery time under normal condition.

5.3. High Temperature Storage

The device should satisfy the electrical characteristics after exposed to temperature 85±5℃ for 96±2 hours and 1~2 hours recovery time under normal temperature.

5.4. Low Temperature Storage

The device should also satisfy the electrical characteristics after exposed to the temperature 40 $^{\circ}\pm^{\circ}$ for 96±2 hours and to 2 hours recovery time under normal temperature.

5.5. Thermal Shock

The device should also satisfy the electrical characteristics after exposed to the low temperature -40 $^{\circ}$ C and high temperature +85 $^{\circ}$ C for 30±2 min each by 5 cycles and 1 to 2 hours recovery time under normal temperature.

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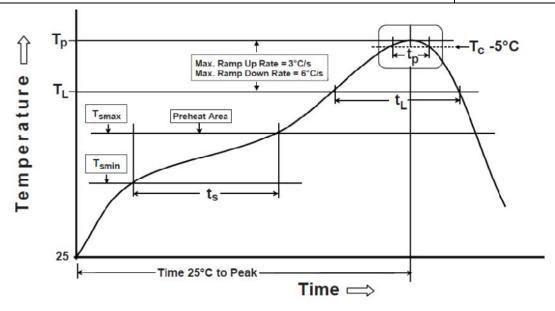




6.NOTICE

- 6.1. RoHS 2.0
- 6.2. MSL-1
- 6.3. Reflow temperature recommendation

Profile feature		Pb-Free Assembly(SnAgCu)
	Temperature Min(Tsmin)	150°C
PREHEAT	Temperature Max(Tsmax)	200°C
	Time(ts) (from Tsmin to Tsmax)	60-120 seconds
RAMP-UP	Ramp-up rate (TL to TP)	3 °C/second max.
REFLOW	Liquidus Temperature(TL)	217°C
	Total Time maintained above TL (t L)	30-100 seconds
PEAK	Temperature(TP)	250°C
PEAN	Time (tp)	25 seconds
RAMP-DOWN	Ramp-down rate (TP to TL)	6 °C / second max.
Time (from 25°C to Peak Temperature) 25°C		8 minutes max.



This product may not be used in the following environments:

- 1. Ambient air containing corrosive gas and volatile or combustible gas.
- 2.In liquid and in environments with a high concentration of airborne particles.

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